

Material Content Data Sheet

RoHS | Halogen-Free

Sales Product Name	IPT007N06N	**Issued**	24. February 2022
MA#	MA005709245		
Package	PG-HSOF-8-1	**Weight***	777.10 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	7.025	0.90	0.90	9040	9040
leadframe	inorganic material	phosphorus	7723-14-0	0.126	0.02		162	
	non noble metal	iron	7439-89-6	0.421	0.05		541	
	non noble metal	copper	7440-50-8	420.040	54.05	54.12	540526	541229
wire	non noble metal	aluminium	7429-90-5	20.222	2.60	2.60	26022	26022
encapsulation	inorganic material	zincoxide	1314-13-2	3.162	0.41		4069	
	miscellaneous	miscellaneous	-	12.647	1.63		16275	
	plastics	epoxy resin	-	47.427	6.10		61031	
	inorganic material	silicondioxide	60676-86-0	252.944	32.55	40.69	325500	406875
leadfinish	non noble metal	tin	7440-31-5	6.479	0.83	0.83	8337	8337
plating	inorganic material	phosphorus	7723-14-0	0.001			2	
	non noble metal	nickel	7440-02-0	0.526	0.07	0.07	677	679
solder	non noble metal	tin	7440-31-5	0.122	0.02		156	
	noble metal	silver	7440-22-4	0.152	0.02		195	
	non noble metal	lead	7439-92-1	5.802	0.75	0.79	7467	7818
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

Company	Infineon Technologies AG
Address	81726 Neubiberg
Internet	www.infineon.com